HKEX 香港交易所

HKEX INFORMATION SERVICES LIMITED
(A wholly-owned member of the Hong Kong Exchanges and Clearing Limited Group)

4 July, 2017   **By Email**
Our Ref: MDD/17/830

To: All Securities Market Data Vendors, End-Users and Application Service Providers (collectively "Clients") and All Independent Software Vendors ("ISVs")

Dear Sirs,

Introduction of Orion Trading Platform for Securities Market (OTP-C)
Updated Connectivity Guide and Canned Data for HKEX Orion Market Data Platform – Securities Market & Index Feed Products (OMD-C)

Our notice of 16 February 2017 (Our Ref: MDD/17/198) informing you of HKEX's plan to introduce a new trading platform, namely Orion Trading Platform for Securities Market (OTP-C), for its Securities Market in the 4th quarter of 2017 refers please.

Please be reminded that there would not be any interface change in OMD-C datafeed products for the rollout of OTP-C. The only change is the real-time dissemination of the OMD-C message Security Status (21) which will be re-located to the existing channels assigned for order book updates from the channel for reference data. This change should be transparent to OMD-C Clients. For details, please refer to the updated OMD-C Connectivity Guide version 2.0 (OMD-C CG) enclosed. Clients can also find the connecitivty details for the access to OMD-C data in the OTP-C End-to-End Test Environment in this updated OMD-C CG.

To illustrate the above change of dissemination channel, a set of OMD-C canned data has been prepared and ready for distribution to Clients and ISVs. Interested Clients and ISVs could obtain the canned data set by completing the online Request Form via this link on or before 14 July 2017.

Clients and ISVs should ensure the readiness of their systems for the Market Rehearsal (MR) scheduled for the 4th quarter of 2017. More details on the MR and the rollout of OTP-C will be provided in due course.

Should you have any queries, please contact us at (852) 2211 6558 or send your questions to IVSupport@hkex.com.hk.

Yours sincerely,

Karen Lam
Vice President
Data Connectivity & Support, Market Data
Markets Division

Enclosure: OMD-C Connectivity Guide version 2.0